

# TPS53119EVM-690 User Guide

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The TPS53119EVM-690 evaluation module allows users to evaluate the Texas Instruments TPS53119, a small-sized, single, buck controller with adaptive on-time D-CAP™ mode control. Included in this document are operating and testing descriptions as well as the EVM schematic, bill of materials, and board layout.

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#### Trademarks

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## 1 Introduction

The TPS53119EVM-690 evaluation module (EVM) uses the TPS53119 device. The TPS53119 is a small-size, single buck controller with adaptive on-time D-CAP™ mode control. It provides a fixed 1.1-V output at up to 25 A from a 12-V input bus. TPS53119EVM-690 also uses the 5-mm × 6-mm TI power block MOSFET (CSD86350Q5D) for high power density and superior thermal performance.

## 2 Description

The TPS53119EVM-690 is designed to use a regulated 12-V bus to produce a regulated 1.1-V output at up to 25 A of load current. The TPS53119EVM-690 is designed to demonstrate the TPS53119 in a typical low-voltage application while providing test points to evaluate the performance of the TPS53119.

### 2.1 Typical Applications

- Point of load systems
- Storage computer
- Server computer
- Multifunction printer
- Embedded computing

### 2.2 Features

The TPS53119EVM-690 features:

- 25-Adc, steady-state output current
- Support prebias output voltage start-up
- High efficiency and high power density by using TI power block MOSFET
- J1 for selectable switching frequency setting
- J2 for selectable internal voltage servo soft start
- J3 for enable function
- J6 for auto-skip and forced CCM selection
- Convenient test points for probing critical waveforms

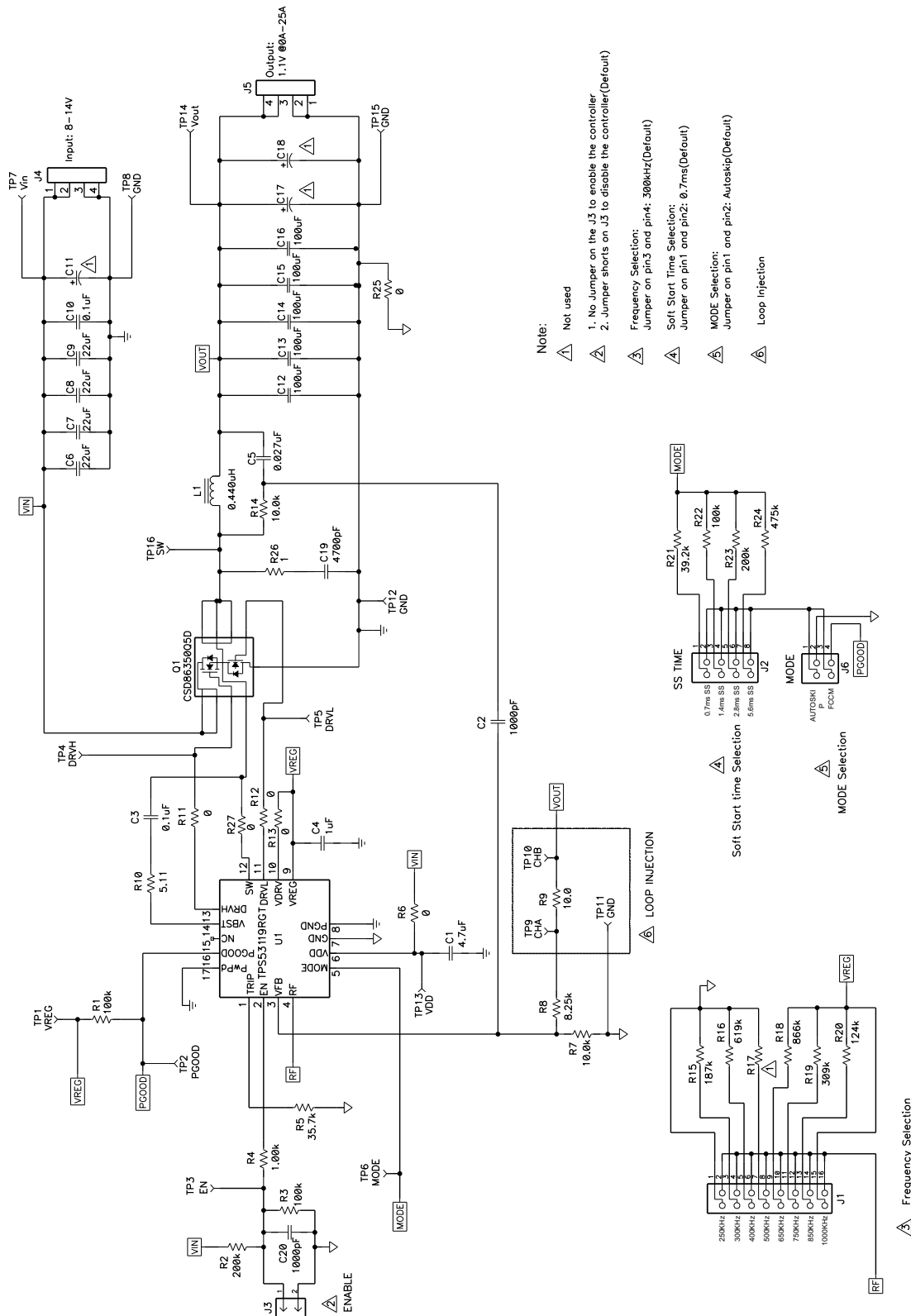
### 3 Electrical Performance Specifications

**Table 1. TPS53119EVM-690 Electrical Performance Specifications**

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>INPUT CHARACTERISTICS</b>					
Voltage range	$V_{IN}$	8	12	14	V
Maximum input current	$V_{IN} = 8\text{ V}$ , $I_{OUT} = 25\text{ A}$		4		A
No load input current	$V_{IN} = 14\text{ V}$ , $I_{OUT} = 0\text{ A}$ with auto-skip mode		1		mA
<b>OUTPUT CHARACTERISTICS</b>					
Output voltage $V_{OUT}$			1.1		V
Output voltage regulation	Line regulation( $V_{IN} = 8\text{ V}$ - $14\text{ V}$ )		0.5%		
	Load regulation( $V_{IN} = 12\text{ V}$ , $I_{OUT} = 0\text{ A}$ - $25\text{ A}$ )		0.5%		
Output voltage ripple	$V_{IN} = 12\text{ V}$ , $I_o = 25\text{ A}$		25		mVpp
Output load current		0		25	A
Output over current			35		A
<b>SYSTEMS CHARACTERISTICS</b>					
Switching frequency			300		kHz
Peak efficiency	$V_{IN} = 12\text{ V}$ , $1.1\text{ V}/10\text{ A}$		90.90%		
Full-load efficiency	$V_{IN} = 12\text{ V}$ , $1.1\text{ V}/25\text{ A}$		88.59%		
Operating temperature			25		°C

**Note:** Jumpers set to default locations, See [Section 6](#) of this user's guide

4 Schematic



- Note:
- △ Not used
  - △ 1. No Jumper on the J3 to enable the controller
  - △ 2. Jumper shorts on J3 to disable the controller(Default)
  - △ Frequency Selection:  
Jumper on pin5 and pin4: 300kHz(Default)
  - △ Soft Start Time Selection:  
Jumper on pin1 and pin2: 0.7ms(Default)
  - △ MODE Selection:  
Jumper on pin1 and pin2: Autoskip(Default)
  - △ Loop Injection

Figure 1. TPS53119EVM-690 Schematic

## 5 Test Setup

### 5.1 Test Equipment

**Voltage Source:** The input voltage source  $V_{IN}$  must be a 0-V to 14-V variable dc source capable of supplying 10 Adc. Connect  $V_{in}$  to J4 as shown in Figure 3.

**Multimeters:**

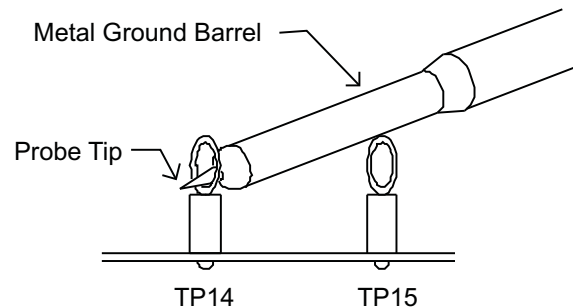
V1:  $V_{IN}$  at TP7 ( $V_{in}$ ) and TP8 (GND).

V2:  $V_{OUT}$  at TP14 ( $V_{out}$ ) and TP15 (GND).

A1:  $V_{in}$  input current

**Output Load:** The output load must be an electronic constant resistance mode load capable of 0 Adc to 30 Adc at 1.1 V.

**Oscilloscope:** A digital or analog oscilloscope can be used to measure the output ripple. The oscilloscope must be set for 1-M $\Omega$  impedance, 20-MHz bandwidth, ac coupling, 2- $\mu$ s/division horizontal resolution, 50-mV/division vertical resolution. Test points TP14 and TP15 can be used to measure the output ripple voltage by placing the oscilloscope probe tip through TP14 and holding the ground barrel on TP15 as shown in Figure 2. Using a leaded ground connection may induce additional noise due to the large ground loop.



**Figure 2. Tip and Barrel Measurement for  $V_{out}$  Ripple**

**Fan:** Some of the components of this EVM may approach temperatures of 60°C during operation. A small fan capable of 200-400 LFM is recommended to reduce component temperatures while the EVM is operating. The EVM must not be probed if the fan is not running.

**Recommended Wire Gauge:**

1.  $V_{IN}$  to J4 (12-V input):

The recommended wire size is 1  $\times$  AWG 14 per input connection, with the total length of wire less than 4 feet (2-foot input, 2-foot return).

2. J5 to LOAD:

The minimum recommended wire size is 2  $\times$  AWG 14, with the total length of wire less than 4 feet (2-foot output, 2-foot return)

## 5.2 Recommended Test Setup

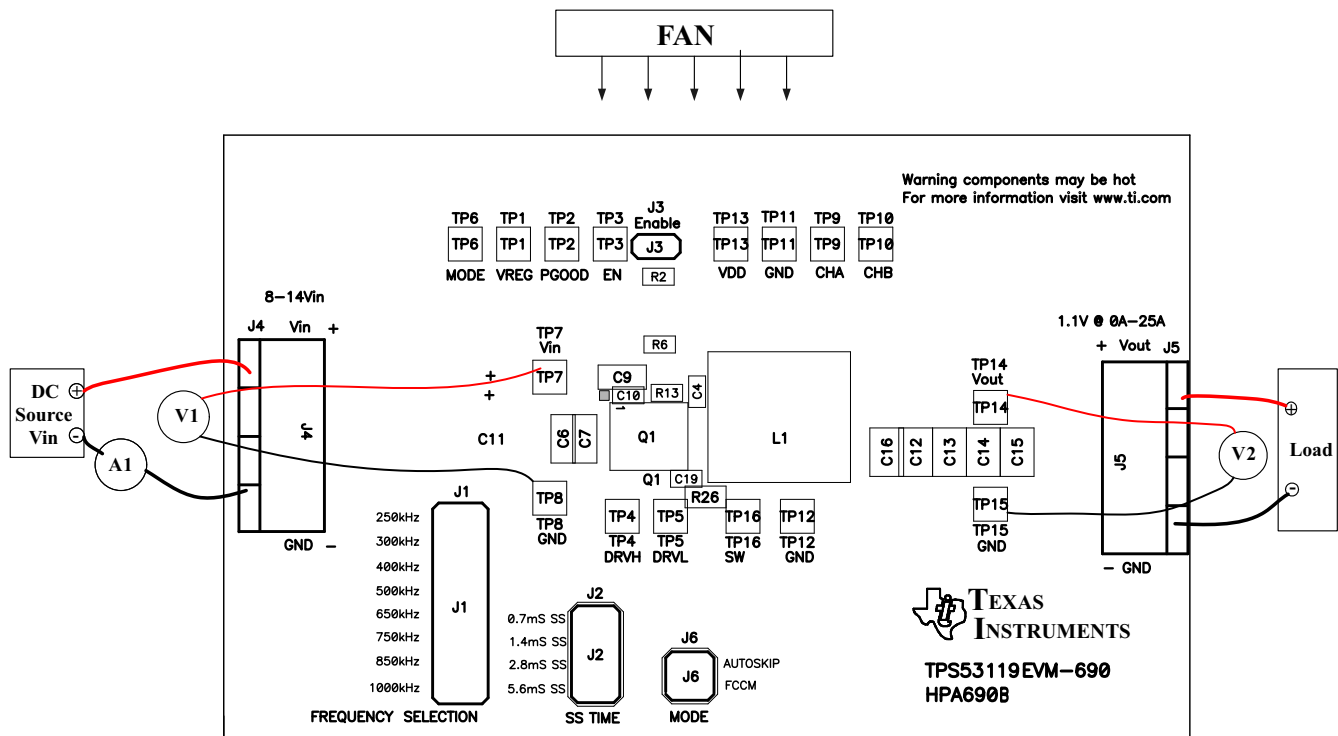


Figure 3. TPS53119EVM-690 Recommended Test Setup

Figure 3 is the recommended test setup to evaluate the TPS53119EVM-690. Working at an ESD workstation, make sure that any wrist straps, bootstraps, or mats are connected referencing the user to earth ground before power is applied to the EVM.

### Input Connections:

1. Prior to connecting the dc input source  $V_{IN}$ , it is advisable to limit the source current from  $V_{IN}$  to 10 A maximum. Ensure that  $V_{IN}$  is initially set to 0 V and connected as shown in Figure 3.
2. Connect a voltmeter V1 at TP7 ( $V_{IN}$ ) and TP8 (GND) to measure the input voltage.
3. Connect a current meter A1 to measure the input current.

### Output Connections:

1. Connect load to J5, and set Load to constant resistance mode to sink 0 Adc before  $V_{IN}$  is applied.
2. Connect a voltmeter V2 at TP14 ( $V_{OUT}$ ) and TP15 (GND) to measure the output voltage.

### Other Connections:

Place a fan as shown in Figure 3 and turn it on, ensuring that air is flowing across the EVM.

## 6 Configurations

All jumper selections must be made prior to applying power to the EVM. Users can configure this EVM per the following configurations.

### 6.1 Switching Frequency Selection

The switching frequency can be set by J1.

**Default setting: 300 kHz**

**Table 2. Switching Frequency Selection**

JUMPER SET TO	RESISTOR (RF) CONNECTIONS ( $\Omega$ )	SWITCHING FREQUENCY (kHz)
Top(1-2 pin shorted)	0	250
<b>Second (3-4 pin shorted)</b>	<b>187 k</b>	<b>300</b>
Third (5-6 pin shorted)	619 k	400
Fourth (7-8 pin shorted)	Open	500
Fifth (9-10 pin shorted)	866 k	650
Sixth (11-12 pin shorted)	309 k	750
Seventh (13-14 pin shorted)	124 k	850
Bottom (15-16 pin shorted)	0	1000

## 6.2 Soft-Start Selection

The soft-start time can be set by J2.

**Default setting: 0.7 ms**

**Table 3. Soft-Start Selection**

JUMPER SET TO	R <sub>MODE</sub> CONNECTIONS ( $\Omega$ )	SOFT-START TIME (ms)
<b>Top (1-2 pin shorted)</b>	<b>39.2 k</b>	<b>0.7</b>
Second (3-4 pin shorted)	100 k	1.4
Third (5-6 pin shorted)	200 k	2.8
Bottom (7-8 pin shorted)	475 k	5.6

## 6.3 Mode Selection

The MODE can be set by J6.

**Default setting: Auto Skip**

**Table 4. MODE Selection**

Jumper Set to	MODE Selection
<b>Top (1-2 pin shorted)</b>	<b>Auto Skip</b>
Bottom (3-4 pin shorted)	Forced CCM

## 6.4 Enable Selection

The controller can be enabled and disabled by J3.

**Default setting: Jumper shorts on J3 to disable the controller**

**Table 5. Enable Selection**

JUMPER SET TO	ENABLE SELECTION
<b>Jumper shorts on J3</b>	<b>Disable the controller</b>
No Jumper shorts on J3	Enable the controller



## 7 Test Procedure

### 7.1 Line/Load Regulation and Efficiency Measurement Procedure

1. Set up EVM as described in [Section 5](#) and [Figure 3](#).
2. Ensure that load is set to constant resistance mode and to sink 0 Adc.
3. Ensure that all jumper configuration settings per [Section 6](#).
4. Ensure that the jumper provided in the EVM shorts on J3 before  $V_{IN}$  is applied.
5. Increase  $V_{IN}$  from 0 V to 12 V. Using V1 to measure input voltage.
6. Remove the jumper on J3 to enable the controller.
7. Use V2 to measure  $V_{OUT}$  voltage.
8. Vary Load from 0-25 Adc;  $V_{OUT}$  must remain in load regulation.
9. Vary  $V_{in}$  from 8 V to 14 V,  $V_{OUT}$  must remain in line regulation.
10. Put the jumper on J3 to disable the controller.
11. Decrease load to 0 A.
12. Decrease  $V_{IN}$  to 0 V.

### 7.2 Control Loop Gain and Phase Measurement Procedure

TPS53119EVM-690 contains a 10- $\Omega$  series resistor in the feedback loop for loop response analysis.

1. Set up EVM as described in [Section 5](#) and [Figure 3](#).
2. Connect isolation transformer to test points marked TP9 and TP10.
3. Connect input signal amplitude measurement probe (channel A) to TP9. Connect output signal amplitude measurement probe (channel B) to TP10.
4. Connect ground lead of channel A and channel B to TP11.
5. Inject approximately 40-mV or less signal through the isolation transformer.
6. Sweep the frequency from 100 Hz to 1 MHz with 10 Hz or lower post filter. The control loop gain and phase margin can be measured.
7. Disconnect isolation transformer from bode plot test points before making other measurements. (Signal injection into feedback may interfere with accuracy of other measurements.)

### 7.3 List of Test Points

**Table 6. Functions of Each Test Points**

TEST POINTS	NAME	DESCRIPTION
TP1	VREG	6.2-V LDO output
TP2	PGOOD	Power Good
TP3	EN	Enable pin
TP4	DRVH	High-side driver output
TP5	DRVL	Low-side driver output
TP6	MODE	Soft-start and auto skip/FCCM selection pin
TP7	V <sub>in</sub>	V <sub>IN</sub>
TP8	GND	GND for V <sub>IN</sub>
TP9	CHA	Input A for loop injection
TP10	CHB	Input B for loop injection
TP11	GND	GND
TP12	GND	GND
TP13	VDD	Controller power supply input
TP14	V <sub>out</sub>	Output voltage
TP15	GND	GND for output voltage

### 7.4 Equipment Shutdown

1. Shut down load.
2. Shut down V<sub>IN</sub>.
3. Shut down FAN.

## 8 Performance Data and Typical Characteristic Curves

Figure 4 through Figure 12 present typical performance curves for TPS53119EVM-690.

### 8.1 Efficiency

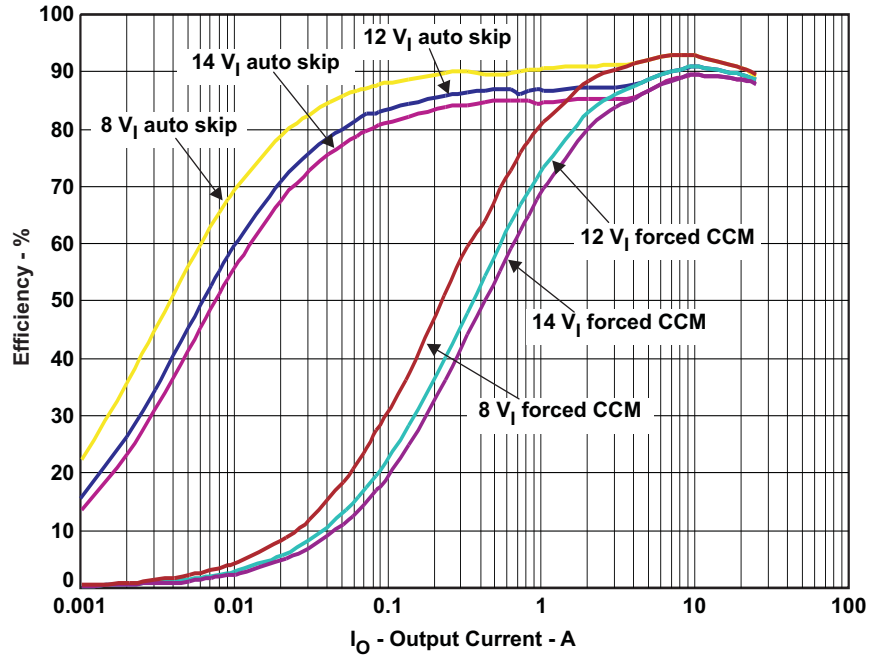


Figure 4. Efficiency

### 8.2 Load Regulation

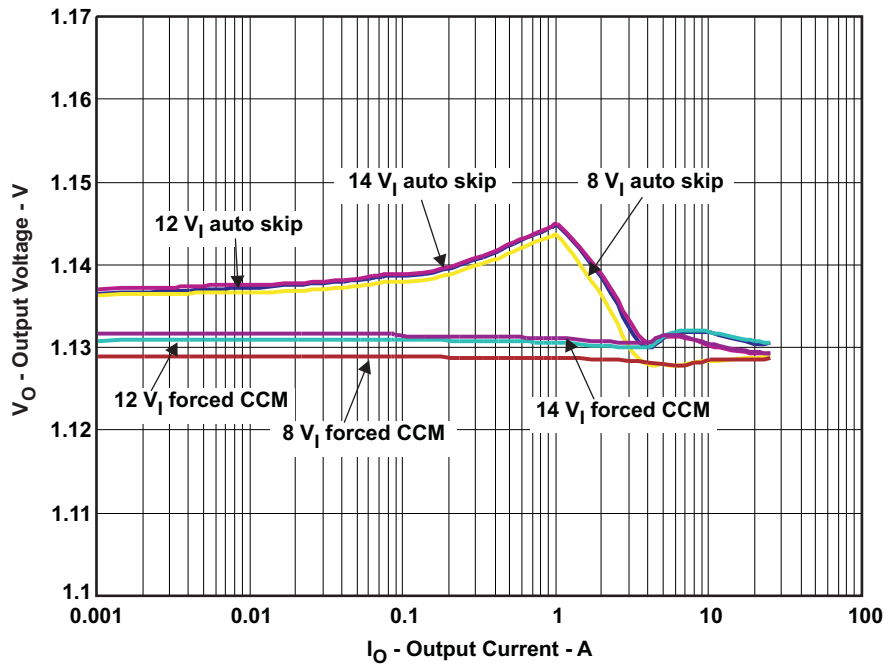
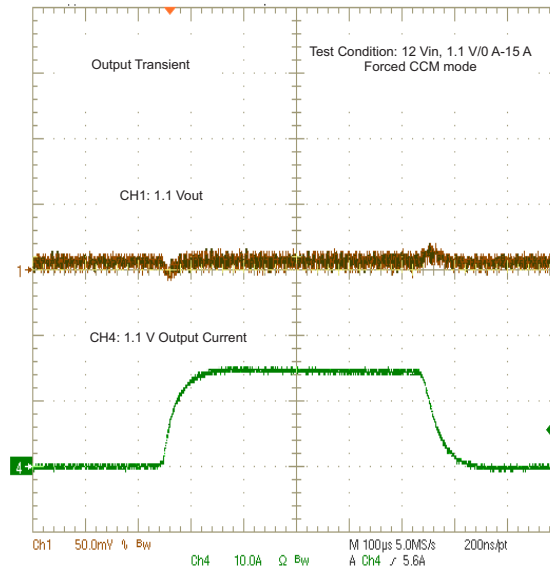
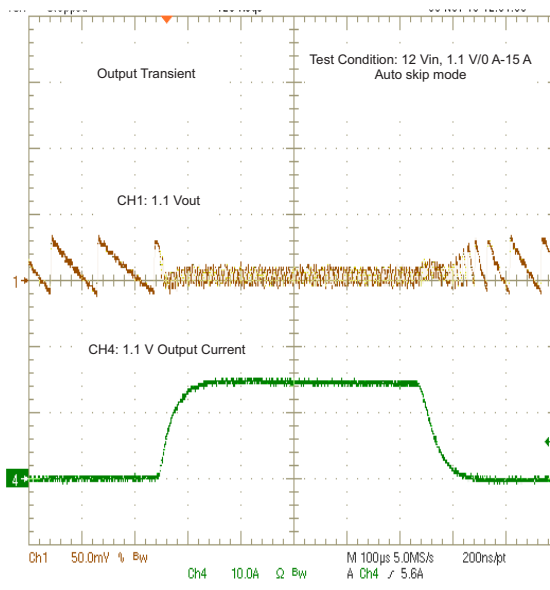


Figure 5. Load Regulation

### 8.3 Output Transient

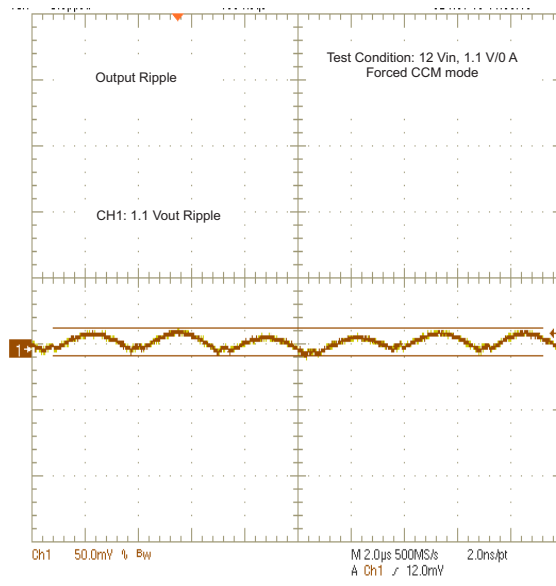


**Figure 6. Output Load Transient**



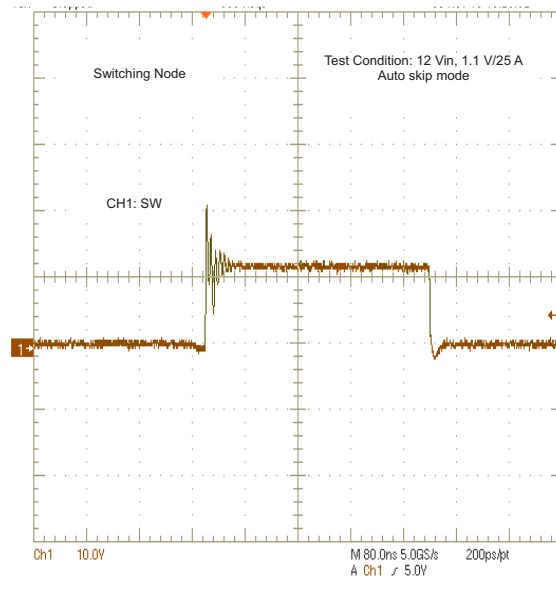
**Figure 7. Output Load Transient**

### 8.4 Output Ripple



**Figure 8. Output Ripple**

### 8.5 Switching Node



**Figure 9. Switching Node**

### 8.6 Enable Turnon/Turnoff

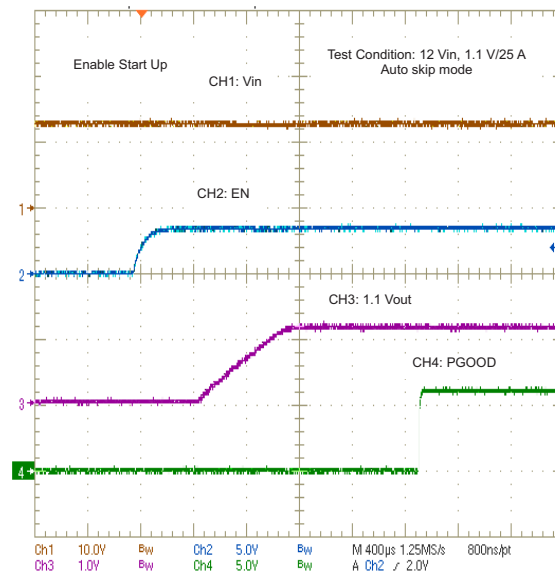


Figure 10. Enable Turnon

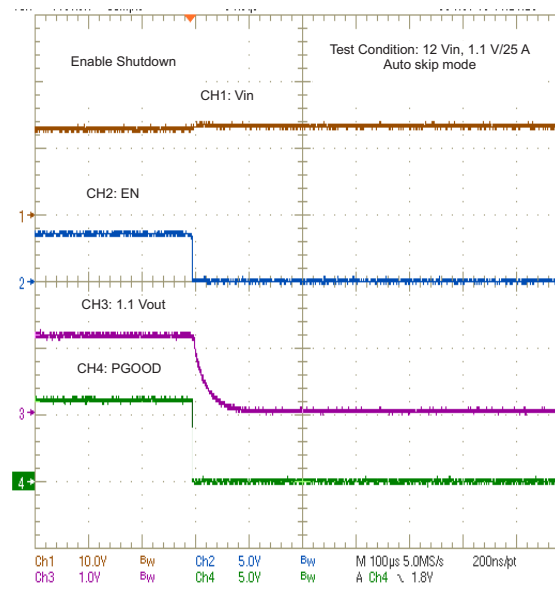


Figure 11. Enable Turnoff

### 8.7 Output 1.1-V Prebias Turnon

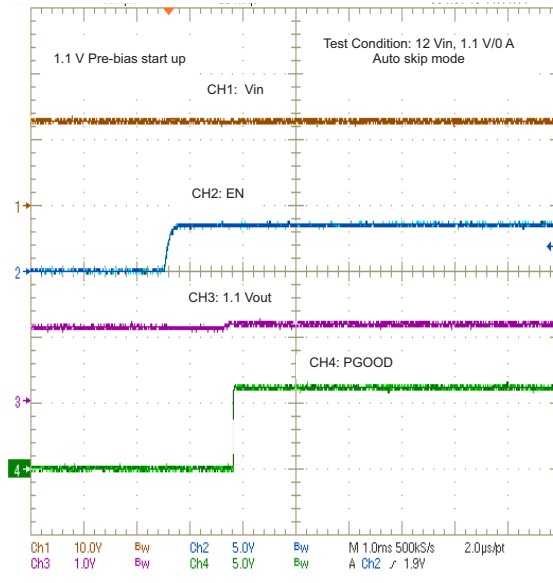


Figure 12. Output 1.1-V Prebias Turnon

### 8.8 Bode Plot

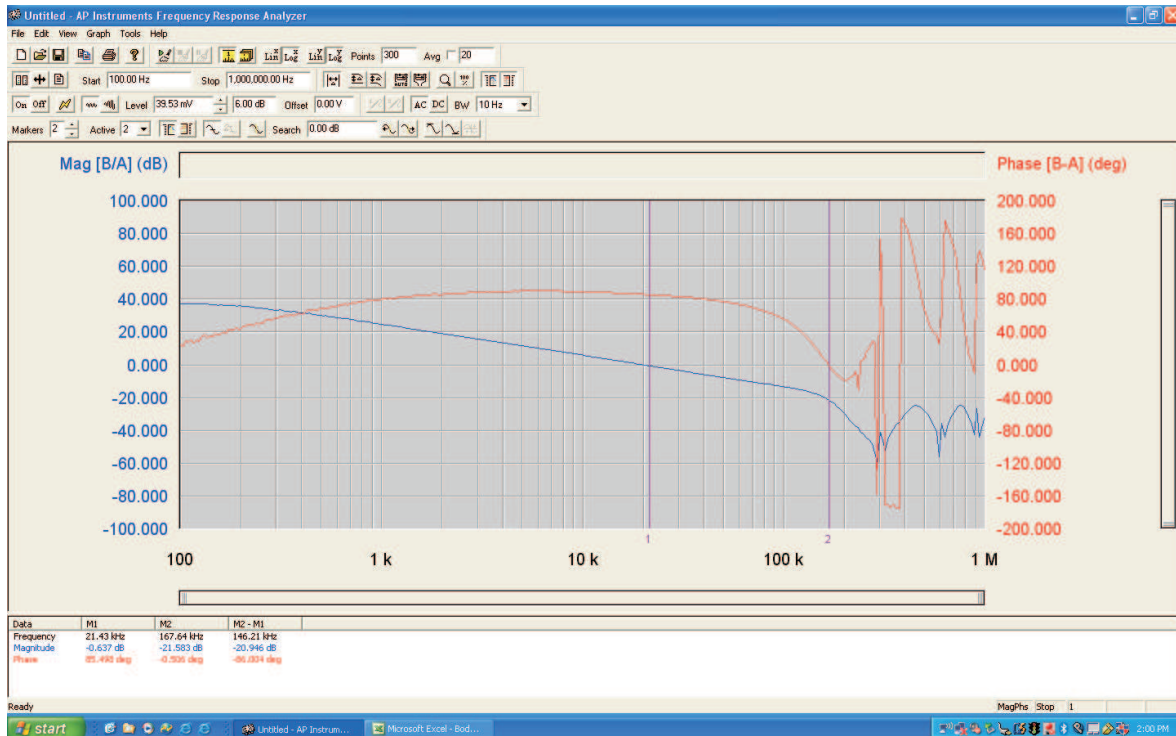


Figure 13. Bode Plot at 12 V<sub>IN</sub>, 1.1 V/25 A

## 8.9 Thermal Image

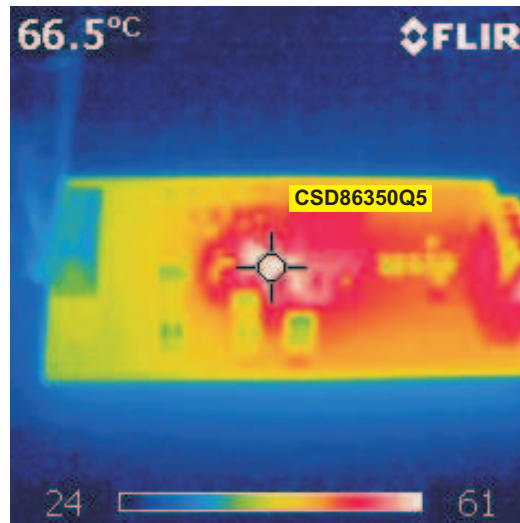


Figure 14. Top Board at 12 V<sub>IN</sub>, 1.1 V/25 A

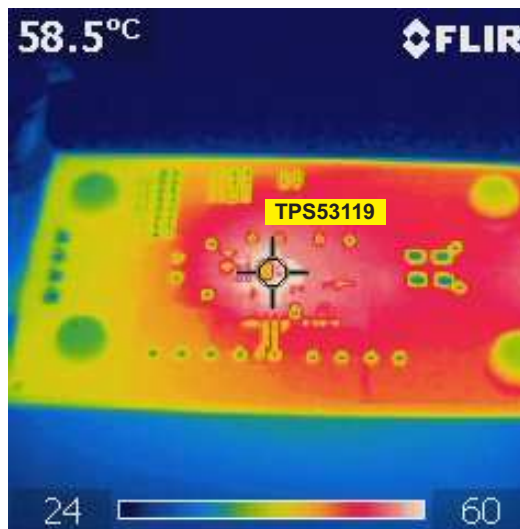


Figure 15. Bottom Board at 12 V<sub>IN</sub>, 1.1 V/25 A



## 9 EVM Assembly Drawing and PCB Layout

Figure 16 through Figure 23 show the design of the TPS53119EVM-690 printed-circuit board. The EVM has been designed using six layers, 2-oz copper circuit board.

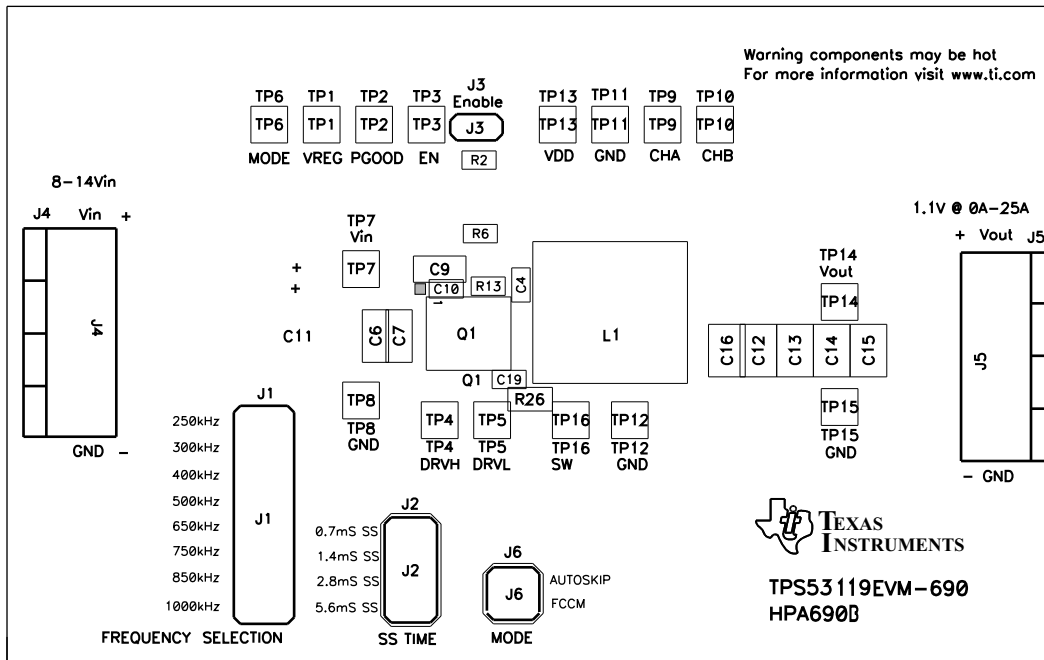


Figure 16. TPS53119EVM-690 Top Layer Assembly Drawing, Top View

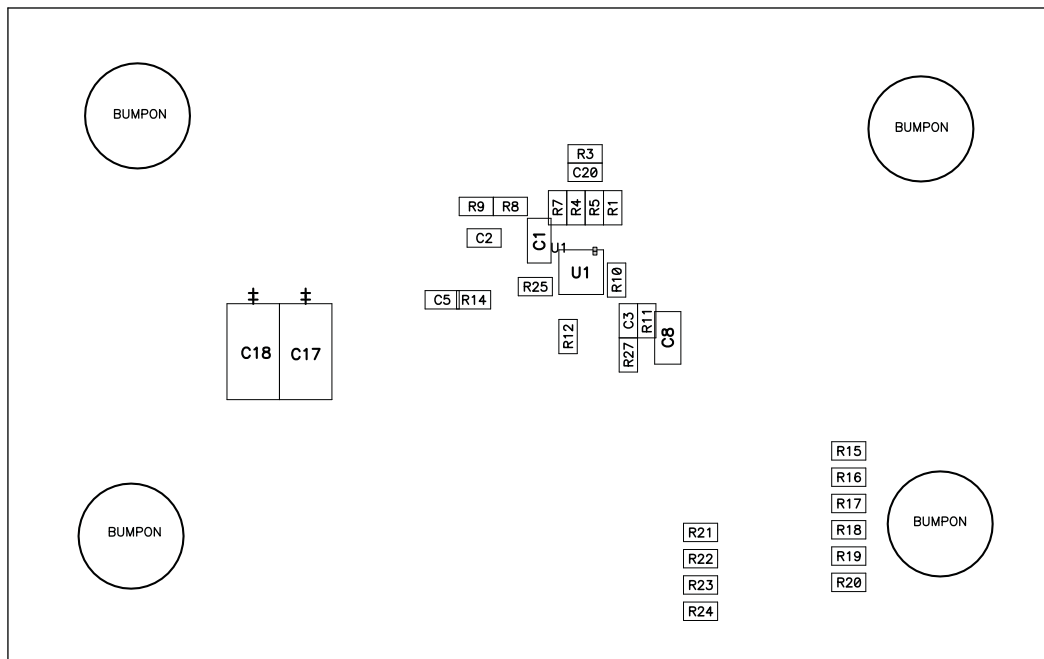
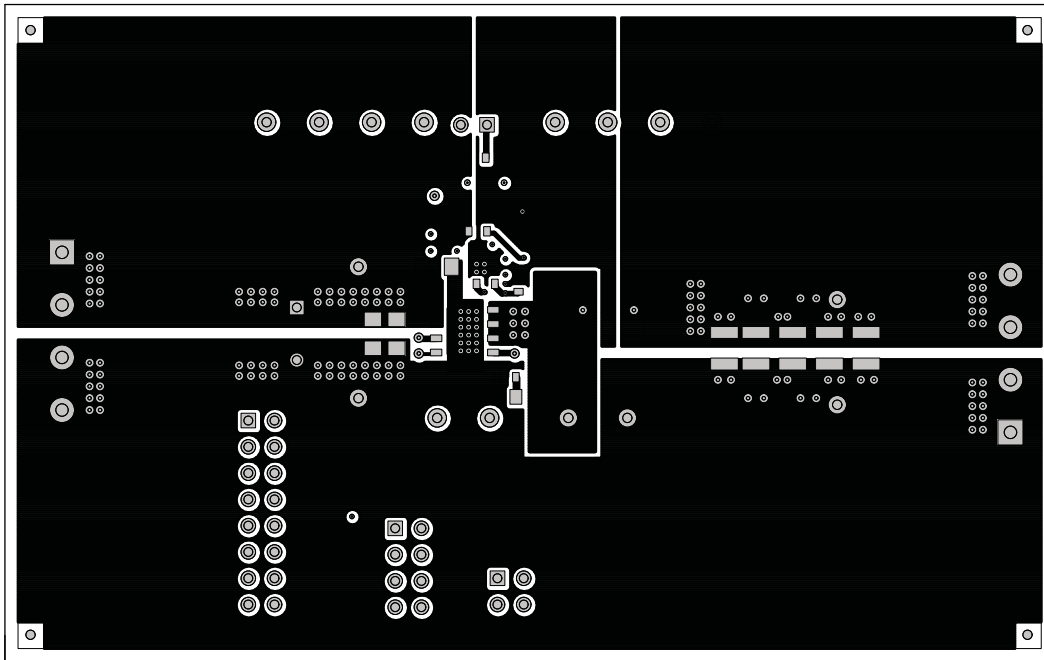
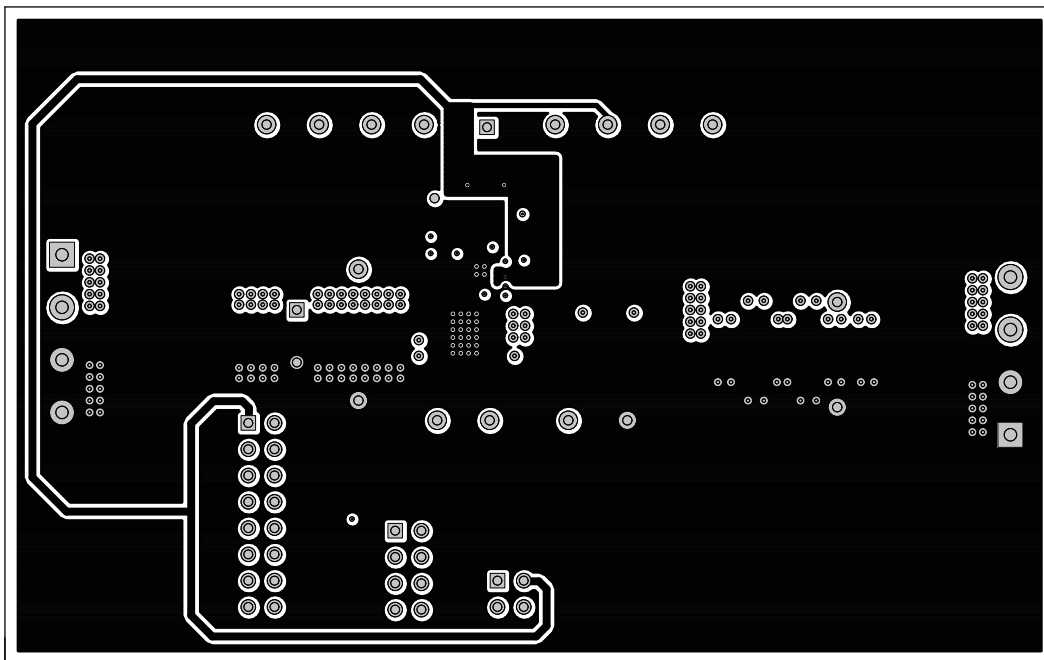


Figure 17. TPS53119EVM-690 Bottom Assembly Drawing, Bottom View



**Figure 18. TPS53119EVM-690 Top Copper, Top View**



**Figure 19. TPS53119EVM-690 Layer-2 Copper, Top View**

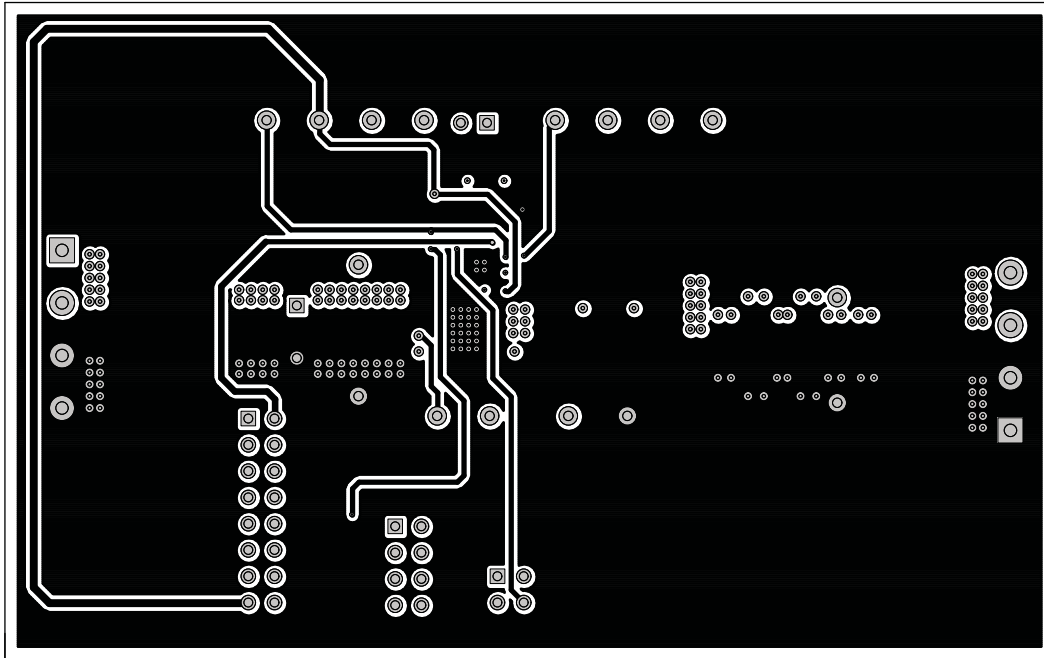


Figure 20. TPS53119EVM-690 Layer-3 Copper, Top View

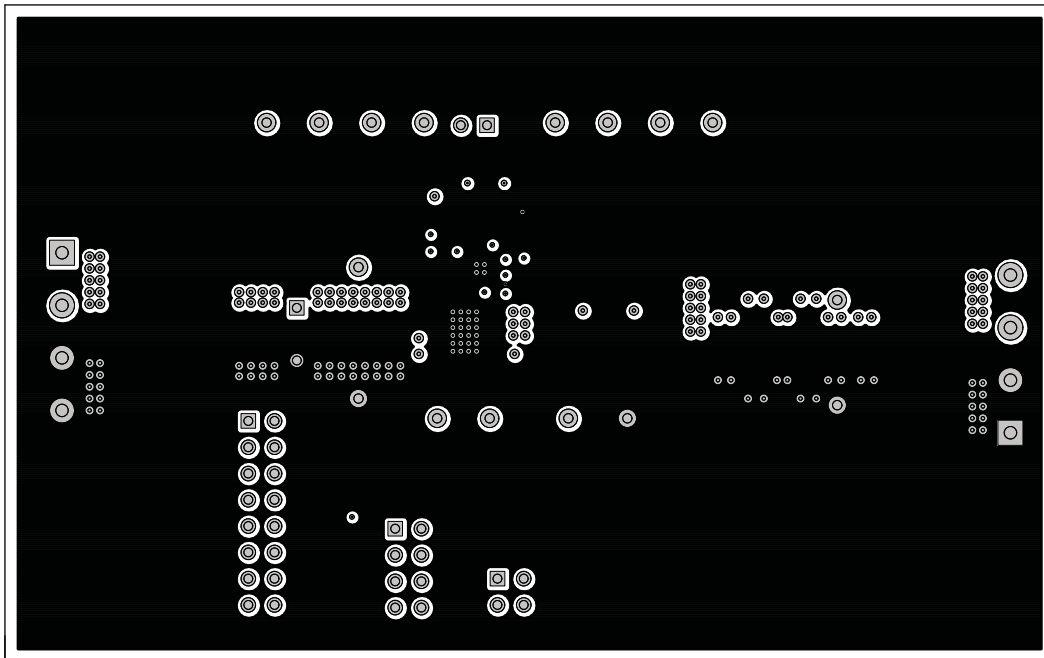


Figure 21. TPS53119EVM-690 Layer-4 Copper, Top View

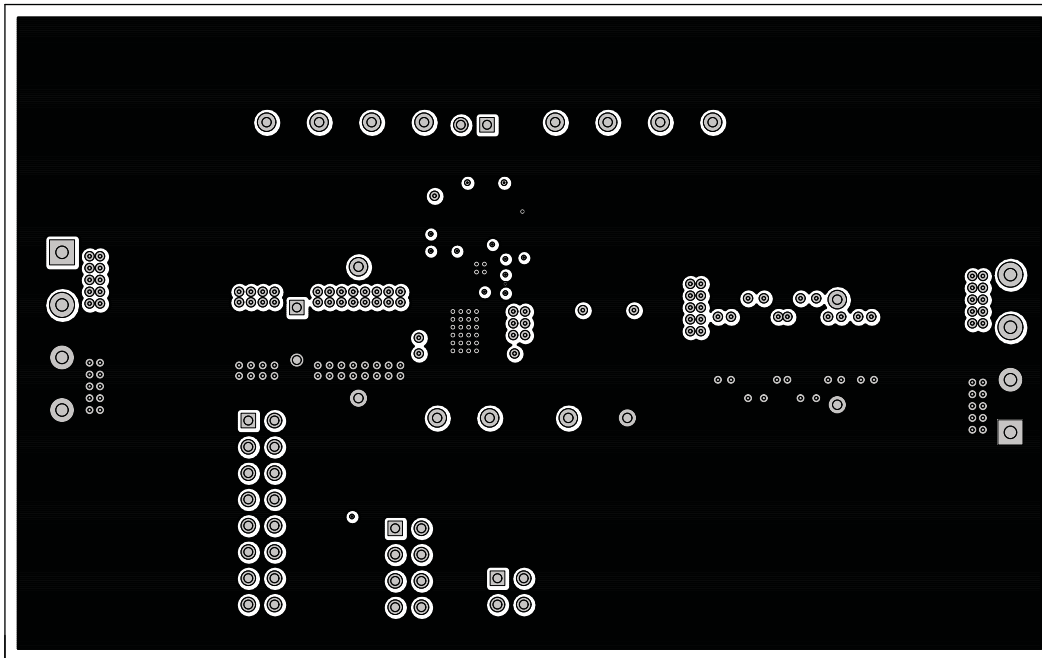


Figure 22. TPS53119EVM-690 Layer-5 Copper, Top View

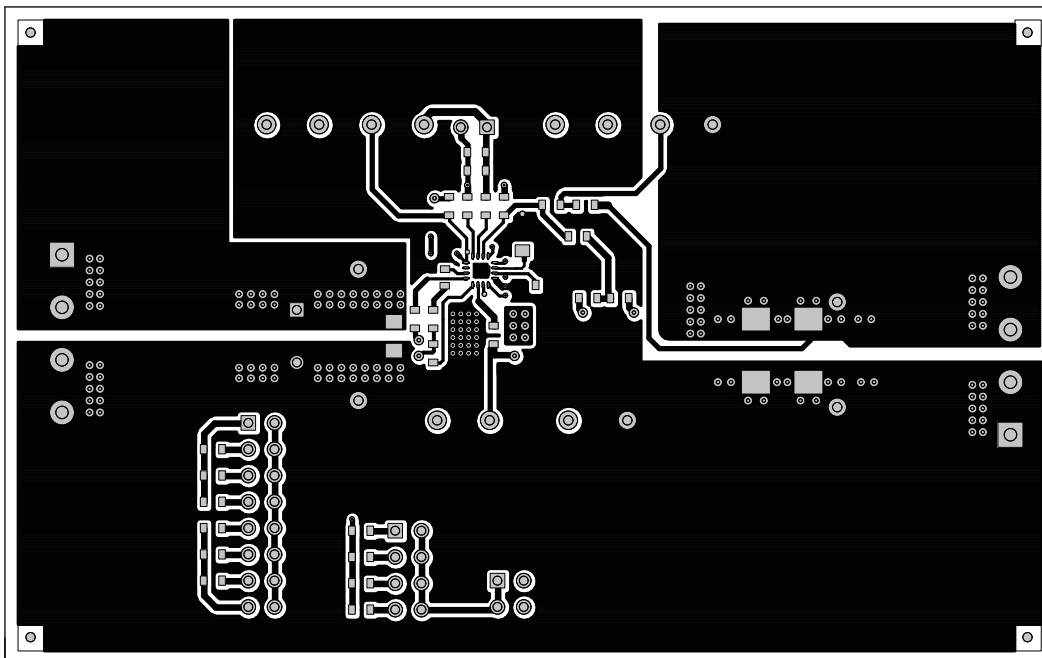


Figure 23. TPS53119EVM-690 Bottom Layer Copper, Top View

## 10 Bill of Materials

**Table 7. The EVM Bill of Materials According to Schematic Shown in Figure 1**

Qty	RefDes	Description	MFR	Part Number
1	C1	Capacitor, Ceramic, 4.7 $\mu$ F, 16V, X5R, 20%, 0805	STD	STD
5	C12–C16	Capacitor, Ceramic, 100 $\mu$ F, 6.3V, X5R, 20%, 1210	Murata	GRM32ER60J107ME20L
1	C19	Capacitor, Ceramic, 4700 pF, 50V, X7R, 20%, 0603	STD	STD
2	C2, C20	Capacitor, Ceramic, 1000 pF, 25V, X7R, 10%, 0603	STD	STD
2	C3, C10	Capacitor, Ceramic, 0.1 $\mu$ F, 50V, X7R, 10%, 0603	STD	STD
1	C5	Capacitor, Ceramic, 0.027 $\mu$ F, 50V, X7R, 10%, 0603	STD	STD
1	C4	Capacitor, Ceramic, 1 $\mu$ F, 16V, X7R, 10%, 0603	STD	STD
4	C6–C9	Capacitor, Ceramic, 22 $\mu$ F, 16V, X5R, 20%, 1206	Murata	GRM31CR61C226ME15L
1	L1	Inductor, SMT, 0.44 $\mu$ H, 30A, 0.0032ohms, 0.530"x0.510"	Pulse or E&E Magnetic	PA0513-441NLT or 831-02990F
1	Q1	MOSFET, Dual N-chan, Power Block, 25V, 40A, QFN-8 Power	TI	CSD86350Q5D
3	R1, R3, R22	Resistor, Chip, 100k, 1/16W, 1%, 0603	STD	STD
1	R15	Resistor, Chip, 187k, 1/16W, 1%, 0603	STD	STD
1	R16	Resistor, Chip, 619k, 1/16W, 1%, 0603	STD	STD
1	R18	Resistor, Chip, 866k, 1/16W, 1%, 0603	STD	STD
1	R19	Resistor, Chip, 309k, 1/16W, 1%, 0603	STD	STD
2	R2, R23	Resistor, Chip, 200k, 1/16W, 1%, 0603	STD	STD
1	R20	Resistor, Chip, 124k, 1/16W, 1%, 0603	STD	STD
1	R21	Resistor, Chip, 39.2k, 1/16W, 1%, 0603	STD	STD
1	R24	Resistor, Chip, 475k, 1/16W, 1%, 0603	STD	STD
1	R26	Resistor, Chip, 1, 1/10W, 5%, 0805	STD	STD
1	R4	Resistor, Chip, 1.00k, 1/16W, 1%, 0603	STD	STD
1	R5	Resistor, Chip, 35.7k, 1/16W, 1%, 0603	STD	STD
6	R6, R11–R13, R25, R27	Resistor, Chip, 0, 1/16W, 5%, 0603	STD	STD
1	R10	Resistor, Chip, 5.11, 1/16W, 1%, 0603	STD	STD
2	R7, R14	Resistor, Chip, 10.0k, 1/16W, 1%, 0603	STD	STD
1	R8	Resistor, Chip, 8.25k, 1/16W, 1%, 0603	STD	STD
1	R9	Resistor, Chip, 10, 1/16W, 1%, 0603	STD	STD
1	U1	IC, Single Synchronous Step-Down Controller	TI	TPS53119RGT

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